chanhvinh.com

Key Features

Up to 3 Watt at 70°C

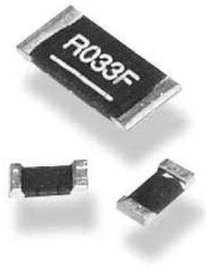
12:06, 20:10, and 25:12 Packages Available

Low Inductance <5nH

AEC-Q200 Qualified

Sulfur Resistant - unaffected by sulfur environments

Type TLRP Series



TE Connectivity (TE) is pleased to offer these unique AEC-Q200 qualified High Power Metal Strip Resistors for Current Sensing positions. TLRP resistors have a special metal resistive element combined with suitable barrier layers beneath the solder to prolong terminal life. This model is particularly useful for power management along with DC-DC converting and charging applications, as well as adaptors within SWPS applications.

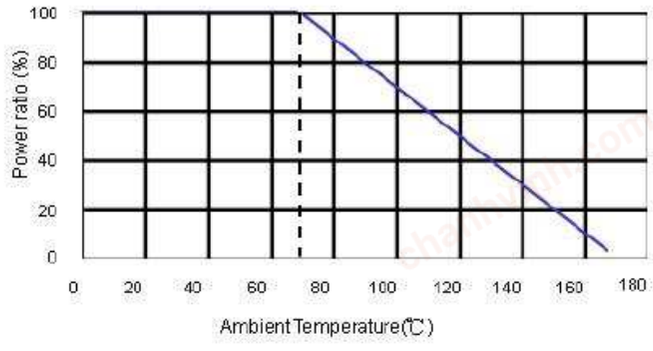
Characteristics – Electrical

Size	Power Rating @ 70°C	Resistance Range (mΩ)			TCR (PPM/°C)
		±0.5%	±1%	±5%	
1206	1W	8, 10, 12, 15, 20, 25, 30, 33, 40			±50
		3, 4, 5, 7, 8, 10, 12, 15, 20, 25, 30, 33, 40			±75 ±100
2010	1W	10, 15, 20, 30, 50, 68, 75, 100			±75
	2W	10, 15, 20, 30, 50			
2512	2W & 3W	3, 4, 5, 6, 7, 18, 20, 22, 25, 30, 33, 35, 39, 40, 47, 50, 60, 68, 70, 75, 80, 82, 90, 91, 100, 120, 150, 180, 200			±25
		3, 4, 5, 6, 7, 8, 9, 10, 12, 15, 18, 20, 22, 25, 30, 33, 35, 39, 40, 47, 50, 60, 68, 70, 75, 80, 82, 90, 91, 100, 120, 150, 180, 200			±50 ±75

Operating Temperature Range: -55 ~ 170°C

Operating Current = √(P/R), Operating Voltage = √(P*R)

Derating



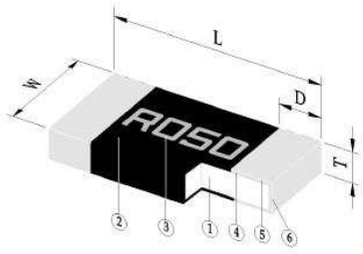
Dimensions in millimetres unless otherwise specified

Dimensions Shown for reference purposes only. Specifications subject to change

For Email, phone or live chat, go to: www.te.com/help

chanhvinh.com

Construction and Dimensions



①	Alloy Plate	④	Internal Electrode
②	Overcoat	⑤	Barrier Layer
③	Marking	⑥	Solder Plating

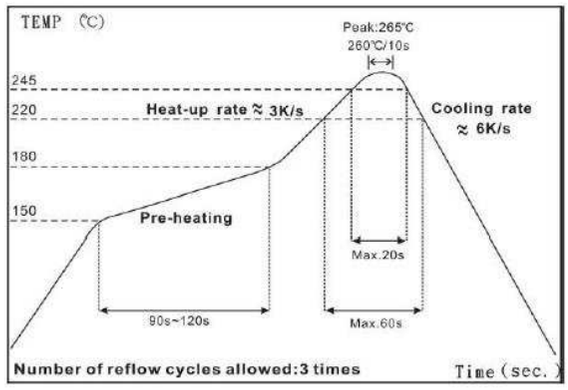
Type	Size	L mm	W mm	T mm	D mm
TLRP2B	1206	3.15±0.10	1.45±0.10	0.55±0.10	0.55±0.15
TLRP2H	2010	5.00±0.10	2.40±0.15	0.60±0.10	0.80±0.20
TLRP3A	2512	6.40±0.25	3.20±0.25	0.70±0.20	0.90±0.30

Marking

Resistance (4 Digit)

Resistance	3mΩ	10mΩ	22mΩ	100mΩ
Codes	R003	R010	R022	R100

Solder Profile (Reflow)



IR Reflow Soldering
(1) Time of IR reflow soldering at maximum temperature point 260°C : 10s

chanhvinh.com

Environmental Characteristics

Item	Requirement	Test Method
Temperature Coefficient of Resistance (T.C.R.)	As Spec.	**IEC60115-1 4.8** **JIS-C-5201-1 4.8** +25°C ~125°C, 25°C is the reference temperature
Short Time Overload	±1.0%	**IEC60115-1 4.13** **JIS-C-5201-1 4.13** 5*rated power for 5 seconds
Insulation Resistance	≥10G	**IEC60115-1 4.6** **JIS-C-5201-1 4.13** 100V DC for 1 minute
Endurance	±1.0%	**IEC60115-1 4.25** **JIS-C-5201-1 4.25.1** 70±2°C, rated power for 1000 hrs with 1.5 hrs “ON” and 0.5 hr “OFF” **MIL-STD-202 Method 108** Condition D Steady State TA=125°C at derated power. Measurement at 24±4 hours after test conclusion.
Biased Humidity	±1.0%	**MIL-STD-202 Method 103** 1000 hrs 85°C/85%RH 10% of operating power
Dry Heat	±1.0%	**IEC60115-1 4.23.2** **JIS-C-5201-1 4.23.2** **MIL-STD-202 Method 108** at +170°C for 1000 hrs
Resistance to Solvents	No visible damage on appearance and marking.	**MIL-STD-202 Method 215** Note: Add Aqueous wash chemical - OKEM Clean or equivalent. Do not use banned solvents.
Mechanical Shock	±1.0%	**MIL-STD-202 Method 213** Wave Form: Tolerance for half sine shock pulse. Peak value is 100g’s. Normal duration(D) is 6.
Vibration	±1.0%	**MIL-STD-202 Method 204** 5g's for 20 min., 12 cycles each of 3 orientations. Note: Use 8"X5" PCB .031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz.
ESD	±1.0%	**AEC-Q200-002** Human body model, 2KV. (DC = Direct Contact Discharge)
Flammability	V-0	**UL-94** 50W (20 mm) Vertical Burning Test. Electrical test not required.

chanhvinh.com

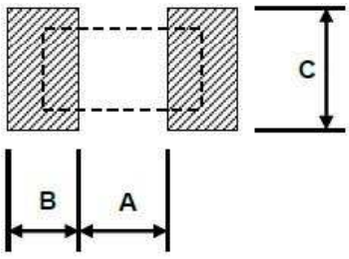
Item	Requirement	Test Method
Flame Retardance	The following phenomena cannot occur during the experiment: (1)A flame over 3.0 seconds duration. (2)An explosion. (3)A temperature above 350°C sustained for over 10 seconds	**AEC-Q200-001** Assemble the sample on the test board, perform functional test before flame retardant test to ensure no damage to the sample. The test environment is 22±5 ℃ still air, from 9.0 to 32.0 VDC (current clamped up to 500A), increase the voltages at the rate of 1.0 VDC per hour until the end of the experiment.
Bending Strength	±1.0%	**JIS-C-5201-1 4.33** **IEC-60115-1 4.33** **AEC-Q200-005** Bending width 2mm once for 5 seconds
Terminal Strength (SMD)	Not broken	**AEC-Q200-006** Force of 1.8kg for 60 seconds.
Solderability	95% min. coverage	**JIS-C-5201-1 4.17** **IEC-60115-1 4.17** **J-STD-002** 245±5°C for 3seconds
Resistance to Soldering Heat	±0.5%	**JIS-C-5201-1 4.18** **IEC-60115-1 4.18** **MIL-STD-202 Method 210** 260±5°C for 10 seconds
Rapid Change of Temperature	±1.0%	**JIS-C-5201-1 4.19** **IEC-60115-1 4.19** -55°C to +155°C, 5 cycles
Temperature Cycling	±1.0%	**JESD22 Method JA-104** 1000 cycles (-55℃ to +125℃, Dwell 30 minutes, transition time within 1 minute). Measurement at 24±4 hours after test conclusion.
Low Temperature Storage	±1.0%	**IEC60115-1 4.23.4** **JIS-C-5201-1 4.23.4** at -55°C for 2hrs

RCWV (Rated Continuous Working Voltage)= √(P*R)or Max. Operating Voltage whichever is lower.

Storage Temperature: 15~28°C; Humidity < 80%RH

chanhvinh.com

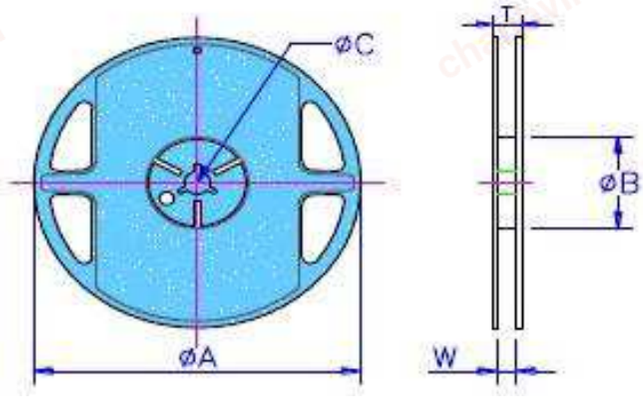
Recommended Land Pattern



Size	A (mm)	B (mm)	C (mm)
1206	1.50	1.40	1.70
2010	3.60	1.40	2.50±0.2
2512	4.00	2.00	3.50
*FR4 copper board, 100µm of copperpad thickness			

Packaging

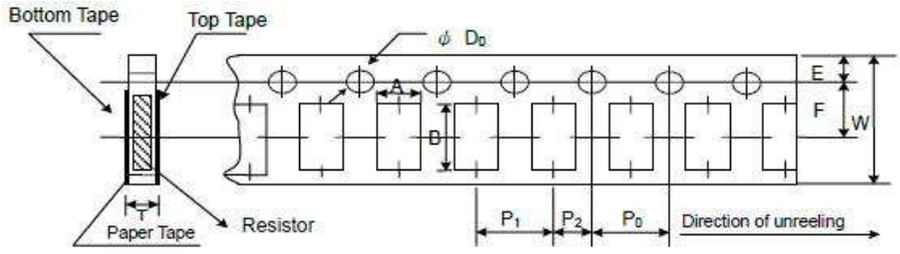
Reel Specifications & Packaging Quantity



Size	Resistance (mΩ	Tape / Qty	Tape width	Reel Dia.	ØA (mm) ±1.5	ØB (mm)	ØC (mm)	W (mm)	T (mm)
1206	3~40	Paper / 5K	8mm	7 inch	178.5	60^{+1-0}	13.0 ±0.2	9.0±0.5	12.5 ±0.5
2010	10~100	Embossed / 4K	12mm			60^{+1-0}	13.0 ±0.5	13.0 ±0.5	15.5 ±0.5
2512	4~200	Embossed / 4K	12mm			60±1.0	13.0 ±0.5	13.0±1. 0	15.5 ±0.5
2512	3	Embossed / 2K	12mm						

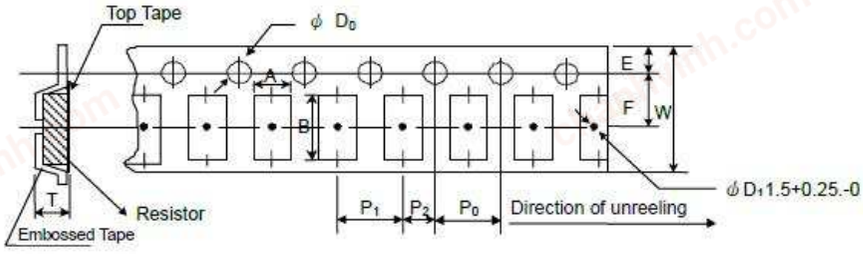
chanhvinh.com

Paper Tape Specification



A (mm)	B (mm)	W (mm)	E (mm)	F (mm)	P_o (mm)	P_1 (mm)	P_2 (mm)	$ØD_o$ (mm)	T (mm)
1.90± 0.10	3.50± 0.20	8.0± 0.20	1.75± 0.10	3.50± 0.05	4.00± 0.10	4.00± 0.05	2.00± 0.05	1.50 +0.1,-0	0.85± 0.10

Embossed Plastic Tape Specification



	A (mm)	B (mm)	W (mm)	E (mm)	F (mm)	P_o (mm)	P_1 (mm)	P_2 (mm)	$ØD_o$ (mm)	T (mm)
2010	2.80 ±0.10	5.5 ±0.10	12.0 ±0.30	0.75 ±0.10	5.5 ±0.5	4.00 ±0.10	4.00 ±0.10	2.00 ±0.05	1.5 +0.1 -0	1.20+0
2512	3.50± 0.10	6.70± 0.10	12.0± 0.30	1.75± 0.10	5.5± 0.05	4.00± 0.10	4.00± 0.10	2.00± 0.05	1.50 +0.1 -0	1.20+0
2512 3mΩ										1.45± 0.2

How To Order

TLRP	2B	10	E	R008	F	TD
Common Part	Size	*Power Rating	**TCR (PPM/°C)	Resistance Code	Tolerance	Packaging
TLRP – Ultra Low Ohm Metal Strip Resistor	2B – 1206 2H - 2010 3A – 2512	1.0 = 10 2.0 = 20 3.0 = 30	C = ±25 D = ±50 W = ±75 E = ±100	R003 - 3mΩ R020 - 20mΩ R10 – 0.1Ω (100mΩ)	D = ±0.5% F = ±1% J = ±5%	TDG = 2000/Reel (2512 3mΩ) TE = 4000/Reel (2512) TD = 5000/Reel (1206)

Dimensions in millimetres unless otherwise specified

Dimensions Shown for reference purposes only. Specifications subject to change

For Email, phone or live chat, go to: www.te.com/help